ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage (I_C = 10 mAdc, I_B = 0)	$V_{(BR)CEO}$	40	–	Vdc
Collector-Base Breakdown Voltage (I_C = 10 μAdc, I_E = 0)	$V_{(BR)CBO}$	75	–	Vdc
Emitter-Base Breakdown Voltage (I_E = 10 μAdc, I_C = 0)	$V_{(BR)EBO}$	6.0	–	Vdc
Base-Emitter Cutoff Current (V_{CE} = 60 Vdc, V_{BE} = − 3.0 Vdc)	I_{BEX}	–	20	nAdc
Collector-Emitter Cutoff Current (V_{CE} = 60 Vdc, V_{BE} = − 3.0 Vdc)	I_{CEX}	–	10	nAdc
Emitter-Base Cutoff Current (V_{EB} = 3.0 Vdc, I_C = 0)	I_{EBO}	–	100	nAdc
Collector-Base Cutoff Current (V_{CB} = 60 Vdc, I_E = 0) (V_{CB} = 60 Vdc, I_E = 0, T_A = 125°C)	I_{CBO}	– –	10 10	 nAdc μAdc
ON CHARACTERISTICS				
DC Current Gain (I_C = 0.1 mAdc, V_{CE} = 10 Vdc) (I_C = 1.0 mAdc, V_{CE} = 10 Vdc) (I_C = 10 mAdc, V_{CE} = 10 Vdc) (I_C = 10 mAdc, V_{CE} = 10 Vdc, T_A = − 55°C) (I_C = 150 mAdc, V_{CE} = 10 Vdc) (I_C = 150 mAdc, V_{CE} = 1.0 Vdc) (I_C = 500 mAdc, V_{CE} = 10 Vdc)	h_{FE}	 35 50 70 35 100 50 40	 – – – – 300 – –	–
Collector-Emitter Saturation Voltages (I_C = 150 mAdc, I_B = 15 mAdc) (I_C = 500 mAdc, I_B = 50 mAdc)	$V_{CE(sat)}$	 – –	 0.3 1.0	Vdc
Base-Emitter Saturation Voltages (I_C = 150 mAdc, I_B = 15 mAdc) (I_C = 500 mAdc, I_B = 50 mAdc)	$V_{BE(sat)}$	 0.6 –	 1.2 2.0	Vdc
Input Impedance (V_{CE} = 10 Vdc, I_C = 1.0 mAdc, f = 1.0 kHz) (V_{CE} = 10 Vdc, I_C = 10 mAdc, f = 1.0 kHz)	h_{ie}	 2.0 0.25	 8.0 1.25	kΩ
Voltage Feedback Ratio (V_{CE} = 10 Vdc, I_C = 1.0 mAdc, f = 1.0 kHz) (V_{CE} = 10 Vdc, I_C = 10 mAdc, f = 1.0 kHz)	h_{re}	 – –	 8.0×10^{-4} 4.0×10^{-4}	–
Small-Signal Current Gain (V_{CE} = 10 Vdc, I_C = 1.0 mAdc, f = 1.0 kHz) (V_{CE} = 10 Vdc, I_C = 10 mAdc, f = 1.0 kHz)	$\lvert h_{fe} \rvert$	 50 75	 300 375	–
Output Admittance (V_{CE} = 10 Vdc, I_C = 1.0 mAdc, f = 1.0 kHz) (V_{CE} = 10 Vdc, I_C = 10 mAdc, f = 1.0 kHz)	h_{oe}	 5.0 25	 35 200	μmhos
Noise Figure (V_{CE} = 10 Vdc, I_C = 100 μAdc, f = 1.0 kHz)	F	–	4.0	dB
DYNAMIC CHARACTERISTICS				
Current-Gain − Bandwidth Product (I_C = 20 mAdc, V_{CE} = 20 Vdc, f = 100 MHz)	f_T	300	–	MHz
Output Capacitance (V_{CB} = 10 Vdc, I_E = 0, f = 1.0 MHz)	C_c	–	8.0	pF
Input Capacitance (V_{EB} = 0.5 Vdc, I_C = 0, f = 1.0 MHz)	C_e	–	25	pF

SWITCHING TIMES (T_A = 25°C)

Characteristic	Conditions	Symbol	Min	Max	Unit
Delay Time	(V_{CC} = 30 Vdc, I_C = 150 mAdc, $I_{B(on)}$ = 15 mAdc, $V_{EB(off)}$ = 0.5 Vdc) Figure 1	t_d	–	10	ns
Rise Time		t_r	–	25	
Storage Time	(V_{CC} = 30 Vdc, I_C = 150 mAdc, $I_{B(on)}$ = $I_{B(off)}$ = 15 mAdc) Figure 2	t_s	–	225	ns
Fall Time		t_f	–	60	

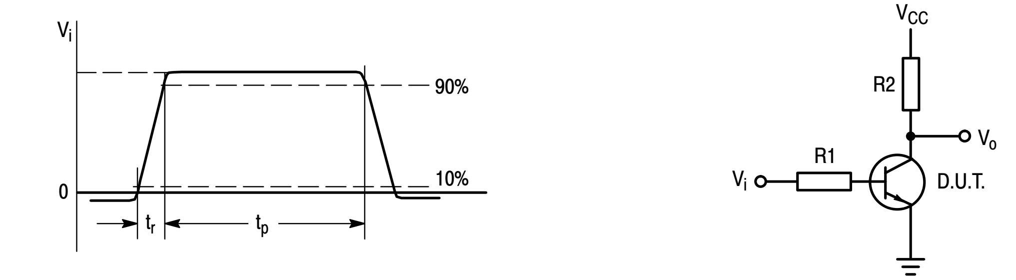


Figure 1. Input Waveform and Test Circuit for Determining Delay Time and Rise Time

V_i = − 0.5 V to +9.9 V, V_{CC} = +30 V, R1 = 619 Ω, R2 = 200 Ω.

PULSE GENERATOR:				**OSCILLOSCOPE:**			
PULSE DURATION	**t_p**	**3**	**200 ns**	**INPUT IMPEDANCE**	**Z_i**	**>**	**100 kΩ**
RISE TIME	**t_r**	**3**	**2 ns**	**INPUT CAPACITANCE**	**C_i**	**<**	**12 pF**
DUTY FACTOR	**δ**	**=**	**0.02**	**RISE TIME**	**t_r**	**<**	**5 ns**

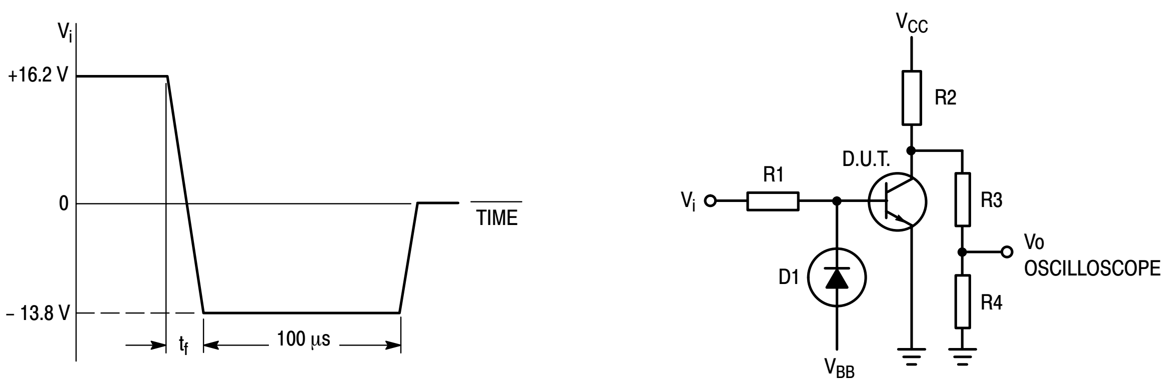
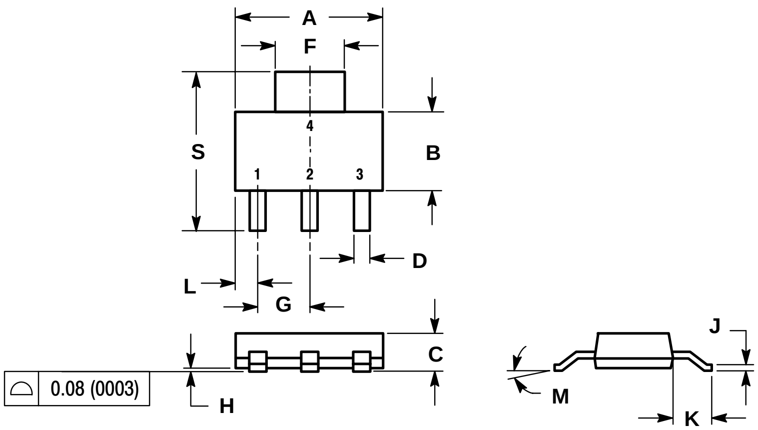


Figure 2. Input Waveform and Test Circuit for Determining Storage Time and Fall Time

PACKAGE DIMENSIONS

SOT−223 (TO−261)
CASE 318E−04
ISSUE K

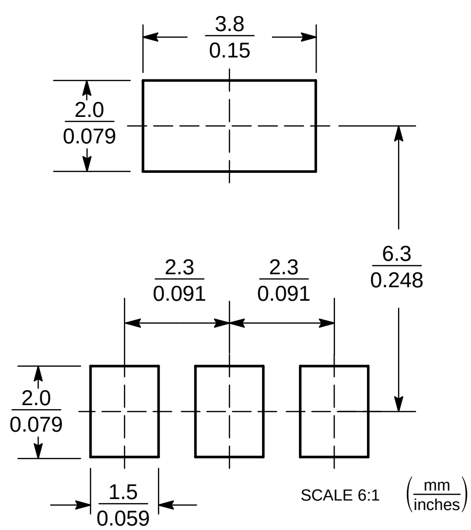


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.249	0.263	6.30	6.70
B	0.130	0.145	3.30	3.70
C	0.060	0.068	1.50	1.75
D	0.024	0.035	0.60	0.89
F	0.115	0.126	2.90	3.20
G	0.087	0.094	2.20	2.40
H	0.0008	0.0040	0.020	0.100
J	0.009	0.014	0.24	0.35
K	0.060	0.078	1.50	2.00
L	0.033	0.041	0.85	1.05
M	0 °	10 °	0 °	10 °
S	0.264	0.287	6.70	7.30

STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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